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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	768B (512 x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	24 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c55-hs-sp">https://www.e-xfl.com/product-detail/microchip-technology/pic16c55-hs-sp</a>

## 5.0 RESET

PIC16C5X devices may be RESET in one of the following ways:

- Power-On Reset (POR)
- $\overline{\text{MCLR}}$  Reset (normal operation)
- $\overline{\text{MCLR}}$  Wake-up Reset (from SLEEP)
- WDT Reset (normal operation)
- WDT Wake-up Reset (from SLEEP)

Table 5-1 shows these RESET conditions for the PCL and STATUS registers.

Some registers are not affected in any RESET condition. Their status is unknown on POR and unchanged in any other RESET. Most other registers are reset to a "RESET state" on Power-On Reset (POR),  $\overline{\text{MCLR}}$  or WDT Reset. A  $\overline{\text{MCLR}}$  or WDT wake-up from SLEEP also results in a device RESET, and not a continuation of operation before SLEEP.

The  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits (STATUS <4:3>) are set or cleared depending on the different RESET conditions (Table 5-1). These bits may be used to determine the nature of the RESET.

Table 5-3 lists a full description of RESET states of all registers. Figure 5-1 shows a simplified block diagram of the On-chip Reset circuit.

**TABLE 5-1: STATUS BITS AND THEIR SIGNIFICANCE**

Condition	$\overline{\text{TO}}$	$\overline{\text{PD}}$
Power-On Reset	1	1
$\overline{\text{MCLR}}$ Reset (normal operation)	u	u
$\overline{\text{MCLR}}$ Wake-up (from SLEEP)	1	0
WDT Reset (normal operation)	0	1
WDT Wake-up (from SLEEP)	0	0

Legend: u = unchanged, x = unknown, – = unimplemented read as '0'.

**TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH RESET**

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on $\overline{\text{MCLR}}$ and WDT Reset
03h	STATUS	PA2	PA1	PA0	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	000q quuu

Legend: u = unchanged, x = unknown, q = see Table 5-1 for possible values.

## 6.7 Indirect Data Addressing; INDF and FSR Registers

The INDF Register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR Register (FSR is a *pointer*). This is indirect addressing.

### EXAMPLE 6-1: INDIRECT ADDRESSING

- Register file 08 contains the value 10h
- Register file 09 contains the value 0Ah
- Load the value 08 into the FSR Register
- A read of the INDF Register will return the value of 10h
- Increment the value of the FSR Register by one (FSR = 09h)
- A read of the INDF register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF Register indirectly results in a no-operation (although STATUS bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 6-2.

### EXAMPLE 6-2: HOW TO CLEAR RAM USING INDIRECT ADDRESSING

```

MOV LW  H'10'    ; initialize pointer
MOV WF  FSR      ; to RAM
NEXT    CLR F    INDF ; clear INDF Register
        INC F    FSR,F ; inc pointer
        BTFSC   FSR,4 ; all done?
        GOTO    NEXT ; NO, clear next

CONTINUE
        :          ; YES, continue
    
```

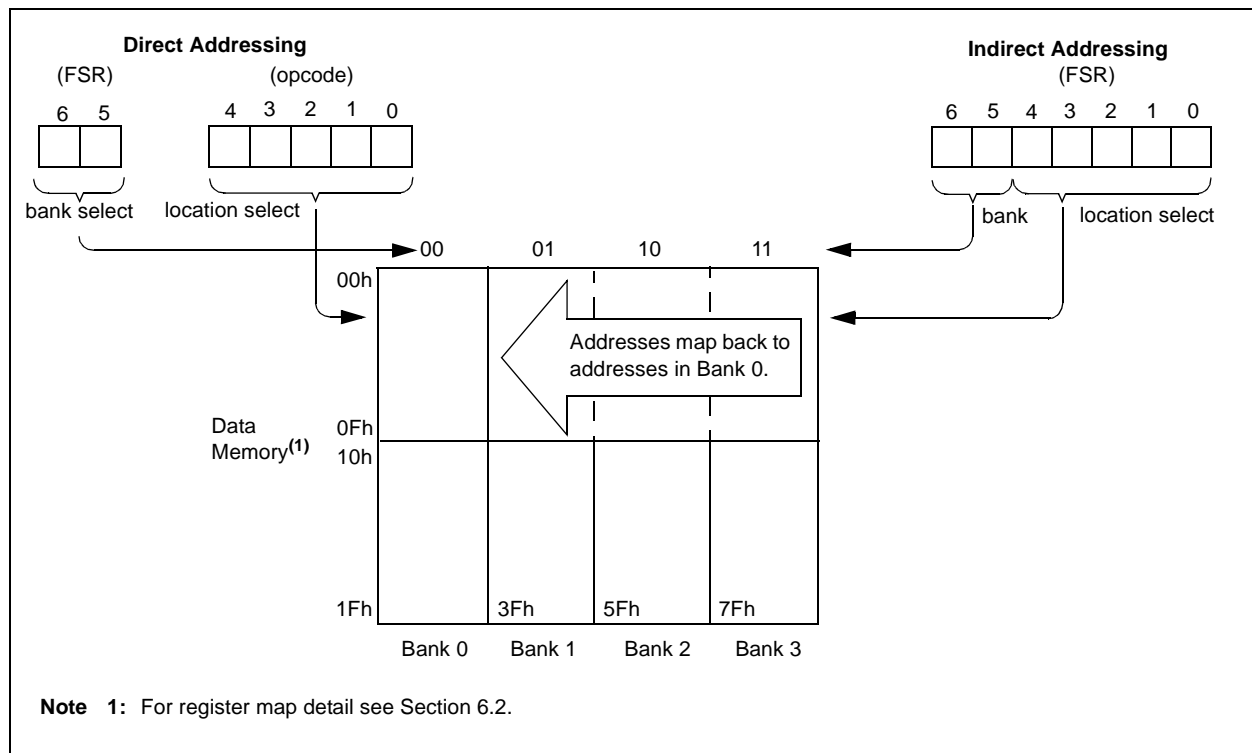
The FSR is either a 5-bit (PIC16C54, PIC16CR54, PIC16C55, PIC16CR55, PIC16C56, PIC16CR56) or 7-bit (PIC16C57, PIC16CR57, PIC16C58, PIC16CR58) wide register. It is used in conjunction with the INDF Register to indirectly address the data memory area.

The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

**PIC16C54, PIC16CR54, PIC16C55, PIC16CR55, PIC16C56, PIC16CR56:** These do not use banking. FSR<6:5> bits are unimplemented and read as '1's.

**PIC16C57, PIC16CR57, PIC16C58, PIC16CR58:** FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = bank 0, 01 = bank 1, 10 = bank 2, 11 = bank 3).

FIGURE 6-10: DIRECT/INDIRECT ADDRESSING



# PIC16C5X

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NOTES:

# PIC16C5X

**TABLE 10-2: INSTRUCTION SET SUMMARY**

Mnemonic, Operands		Description	Cycles	12-Bit Opcode			Status Affected	Notes
				MSb	LSb			
ADDWF	f, d	Add W and f	1	0001	11df	ffff	C, DC, Z	1, 2, 4
ANDWF	f, d	AND W with f	1	0001	01df	ffff	Z	2, 4
CLRF	f	Clear f	1	0000	011f	ffff	Z	4
CLRW	—	Clear W	1	0000	0100	0000	Z	
COMF	f, d	Complement f	1	0010	01df	ffff	Z	
DECF	f, d	Decrement f	1	0000	11df	ffff	Z	2, 4
DECFSZ	f, d	Decrement f, Skip if 0	1 (2)	0010	11df	ffff	None	2, 4
INCF	f, d	Increment f	1	0010	10df	ffff	Z	2, 4
INCFSZ	f, d	Increment f, Skip if 0	1 (2)	0011	11df	ffff	None	2, 4
IORWF	f, d	Inclusive OR W with f	1	0001	00df	ffff	Z	2, 4
MOVF	f, d	Move f	1	0010	00df	ffff	Z	2, 4
MOVWF	f	Move W to f	1	0000	001f	ffff	None	1, 4
NOP	—	No Operation	1	0000	0000	0000	None	
RLF	f, d	Rotate left f through Carry	1	0011	01df	ffff	C	2, 4
RRF	f, d	Rotate right f through Carry	1	0011	00df	ffff	C	2, 4
SUBWF	f, d	Subtract W from f	1	0000	10df	ffff	C, DC, Z	1, 2, 4
SWAPF	f, d	Swap f	1	0011	10df	ffff	None	2, 4
XORWF	f, d	Exclusive OR W with f	1	0001	10df	ffff	Z	2, 4
BIT-ORIENTED FILE REGISTER OPERATIONS								
BCF	f, b	Bit Clear f	1	0100	bbbf	ffff	None	2, 4
BSF	f, b	Bit Set f	1	0101	bbbf	ffff	None	2, 4
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	0110	bbbf	ffff	None	
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	0111	bbbf	ffff	None	
LITERAL AND CONTROL OPERATIONS								
ANDLW	k	AND literal with W	1	1110	kkkk	kkkk	Z	1
CALL	k	Call subroutine	2	1001	kkkk	kkkk	None	
CLRWDT	k	Clear Watchdog Timer	1	0000	0000	0100	TO, PD	
GOTO	k	Unconditional branch	2	101k	kkkk	kkkk	None	
IORLW	k	Inclusive OR Literal with W	1	1101	kkkk	kkkk	Z	
MOVLW	k	Move Literal to W	1	1100	kkkk	kkkk	None	
OPTION	k	Load OPTION register	1	0000	0000	0010	None	
RETLW	k	Return, place Literal in W	2	1000	kkkk	kkkk	None	
SLEEP	—	Go into standby mode	1	0000	0000	0011	TO, PD	
TRIS	f	Load TRIS register	1	0000	0000	0fff	None	3
XORLW	k	Exclusive OR Literal to W	1	1111	kkkk	kkkk	Z	

**Note 1:** The 9th bit of the program counter will be forced to a '0' by any instruction that writes to the PC except for GOTO (see Section 6.5 for more on program counter).

- When an I/O register is modified as a function of itself (e.g. `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
- The instruction `TRIS f`, where  $f = 5, 6$  or  $7$  causes the contents of the W register to be written to the tristate latches of PORTA, B or C respectively. A '1' forces the pin to a hi-impedance state and disables the output buffers.
- If this instruction is executed on the TMR0 register (and, where applicable,  $d = 1$ ), the prescaler will be cleared (if assigned to TMR0).

# PIC16C5X

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## **XORLW** Exclusive OR literal with W

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Syntax: `[label] XORLW k`

Operands:  $0 \leq k \leq 255$

Operation:  $(W) .XOR. k \rightarrow (W)$

Status Affected: Z

Encoding: 

1111	kkkk	kkkk
------	------	------

Description: The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Example: `XORLW 0xAF`

Before Instruction

W = 0xB5

After Instruction

W = 0x1A

## **XORWF** Exclusive OR W with f

---

Syntax: `[label] XORWF f,d`

Operands:  $0 \leq f \leq 31$   
 $d \in [0,1]$

Operation:  $(W) .XOR. (f) \rightarrow (dest)$

Status Affected: Z

Encoding: 

0001	10df	ffff
------	------	------

Description: Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example `XORWF REG,1`

Before Instruction

REG = 0xAF

W = 0xB5

After Instruction

REG = 0x1A

W = 0xB5

## 11.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

## 11.14 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

## 11.15 KEELoQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.

## 12.0 ELECTRICAL CHARACTERISTICS - PIC16C54A

### Absolute Maximum Ratings<sup>(†)</sup>

Ambient Temperature under bias .....	–55°C to +125°C
Storage Temperature .....	–65°C to +150°C
Voltage on VDD with respect to VSS .....	0V to +7.5V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS <sup>(1)</sup> .....	0V to +14V
Voltage on all other pins with respect to VSS .....	–0.6V to (VDD + 0.6V)
Total power dissipation <sup>(2)</sup> .....	800 mW
Max. current out of VSS pin .....	150 mA
Max. current into VDD pin .....	100 mA
Max. current into an input pin (T0CKI only).....	±500 $\mu$ A
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD) .....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD) .....	±20 mA
Max. output current sunk by any I/O pin .....	25 mA
Max. output current sourced by any I/O pin .....	20 mA
Max. output current sourced by a single I/O port (PORTA, B or C) .....	40 mA
Max. output current sunk by a single I/O port (PORTA, B or C).....	50 mA

**Note 1:** Voltage spikes below VSS at the  $\overline{\text{MCLR}}$  pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50 to 100  $\Omega$  should be used when applying a “low” level to the  $\overline{\text{MCLR}}$  pin rather than pulling this pin directly to VSS.

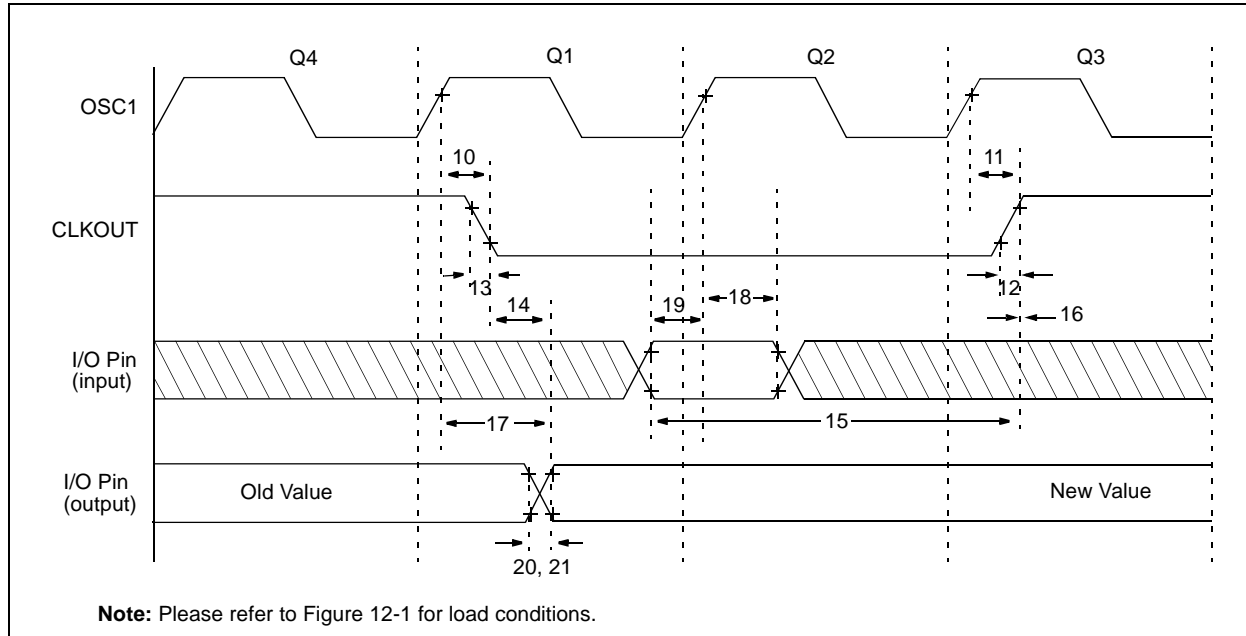
**2:** Power Dissipation is calculated as follows:  $P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

† NOTICE: Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.



# PIC16C5X

**FIGURE 12-3: CLKOUT AND I/O TIMING - PIC16C54/55/56/57**



**TABLE 12-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C54/55/56/57**

Standard Operating Conditions (unless otherwise specified)						
Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended						
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units
10	TosH2ckL	OSC1↑ to CLKOUT↓ <sup>(1)</sup>	—	15	30**	ns
11	TosH2ckH	OSC1↑ to CLKOUT↑ <sup>(1)</sup>	—	15	30**	ns
12	TckR	CLKOUT rise time <sup>(1)</sup>	—	5.0	15**	ns
13	TckF	CLKOUT fall time <sup>(1)</sup>	—	5.0	15**	ns
14	TckL2ioV	CLKOUT↓ to Port out valid <sup>(1)</sup>	—	—	40**	ns
15	TioV2ckH	Port in valid before CLKOUT↑ <sup>(1)</sup>	0.25 TCY+30*	—	—	ns
16	TckH2ioI	Port in hold after CLKOUT↑ <sup>(1)</sup>	0*	—	—	ns
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid <sup>(2)</sup>	—	—	100*	ns
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns
20	TioR	Port output rise time <sup>(2)</sup>	—	10	25**	ns
21	TioF	Port output fall time <sup>(2)</sup>	—	10	25**	ns

\* These parameters are characterized but not tested.

\*\* These parameters are design targets and are not tested. No characterization data available at this time.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

**2:** Please refer to Figure 12-1 for load conditions.

# PIC16C5X

## 13.4 DC Characteristics: PIC16CR54A-04E, 10E, 20E (Extended)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
D030	V <sub>IL</sub>	<b>Input Low Voltage</b> I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1	V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub> V <sub>SS</sub>	— — — — —	0.15 V <sub>DD</sub> 0.15 V <sub>DD</sub> 0.15 V <sub>DD</sub> 0.15 V <sub>DD</sub> 0.3 V <sub>DD</sub>	V V V V V	Pin at hi-impedance   RC mode only <sup>(3)</sup> XT, HS and LP modes
D040	V <sub>IH</sub>	<b>Input High Voltage</b> I/O ports I/O ports I/O ports MCLR (Schmitt Trigger) T0CKI (Schmitt Trigger) OSC1 (Schmitt Trigger) OSC1	0.45 V <sub>DD</sub> 2.0 0.36 V <sub>DD</sub> 0.85 V <sub>DD</sub> 0.85 V <sub>DD</sub> 0.85 V <sub>DD</sub> 0.7 V <sub>DD</sub>	— — — — — — —	V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub>	V V V V V V V	For all V <sub>DD</sub> <sup>(4)</sup> 4.0V < V <sub>DD</sub> ≤ 5.5V <sup>(4)</sup> V <sub>DD</sub> > 5.5V  RC mode only <sup>(3)</sup> XT, HS and LP modes
D050	V <sub>HYS</sub>	<b>Hysteresis of Schmitt Trigger inputs</b>	0.15 V <sub>DD</sub> *	—	—	V	
D060	I <sub>IL</sub>	<b>Input Leakage Current<sup>(1,2)</sup></b> I/O ports  MCLR MCLR T0CKI OSC1	−1.0  −5.0 — −3.0 −3.0	0.5  — 0.5 0.5 0.5	+1.0  — +5.0 +3.0 +3.0	μA  μA μA μA μA	<b>For V<sub>DD</sub> ≤ 5.5V:</b> V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , pin at hi-impedance V <sub>PIN</sub> = V <sub>SS</sub> + 0.25V V <sub>PIN</sub> = V <sub>DD</sub> V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , XT, HS and LP modes
D080	V <sub>OL</sub>	<b>Output Low Voltage</b> I/O ports OSC2/CLKOUT	— —	— —	0.6 0.6	V V	I <sub>OL</sub> = 8.7 mA, V <sub>DD</sub> = 4.5V I <sub>OL</sub> = 1.6 mA, V <sub>DD</sub> = 4.5V, RC mode only
D090	V <sub>OH</sub>	<b>Output High Voltage<sup>(2)</sup></b> I/O ports OSC2/CLKOUT	V <sub>DD</sub> − 0.7 V <sub>DD</sub> − 0.7	— —	— —	V V	I <sub>OH</sub> = −5.4 mA, V <sub>DD</sub> = 4.5V I <sub>OH</sub> = −1.0 mA, V <sub>DD</sub> = 4.5V, RC mode only

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

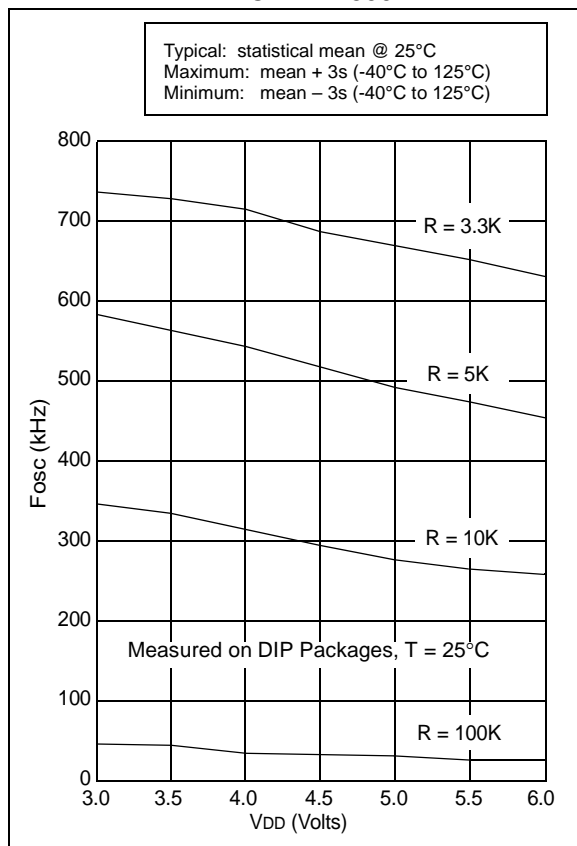
**Note 1:** The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

**2:** Negative current is defined as coming out of the pin.

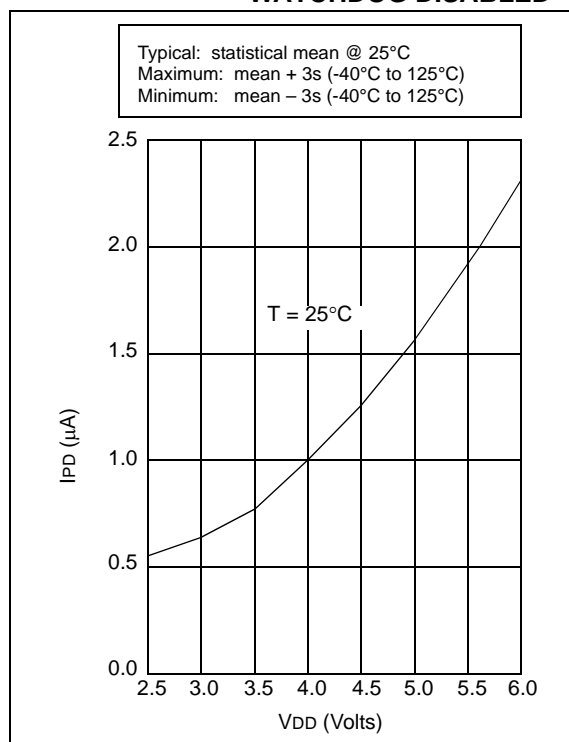
**3:** For the RC mode, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C5X be driven with external clock in RC mode.

**4:** The user may use the better of the two specifications.

**FIGURE 14-4: TYPICAL RC OSC FREQUENCY vs. V<sub>DD</sub>, CEXT = 300 PF**



**FIGURE 14-5: TYPICAL IPD vs. V<sub>DD</sub>, WATCHDOG DISABLED**



## 15.2 DC Characteristics: PIC16C54A-04E, 10E, 20E (Extended) PIC16LC54A-04E (Extended)

PIC16LC54A-04E (Extended)		Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
PIC16C54A-04E, 10E, 20E (Extended)		Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
D020	IPD	<b>Power-down Current<sup>(2)</sup></b>					
		PIC16LC54A	—	2.5	15	$\mu\text{A}$	VDD = 2.5V, WDT enabled, Extended
			—	0.25	7.0	$\mu\text{A}$	VDD = 2.5V, WDT disabled, Extended
D020A		PIC16C54A	—	5.0	22	$\mu\text{A}$	VDD = 3.5V, WDT enabled
			—	0.8	18*	$\mu\text{A}$	VDD = 3.5V, WDT disabled

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

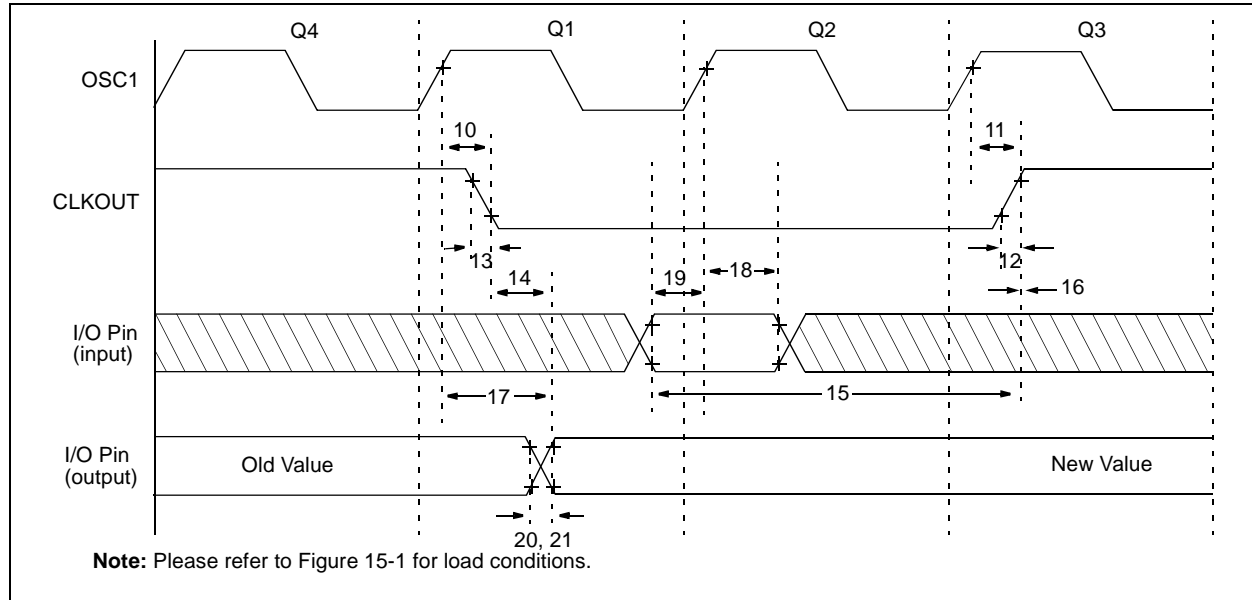
**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**3:** Does not include current through REXT. The current through the resistor can be estimated by the formula:  $I_R = V_{DD}/2R_{EXT}$  (mA) with REXT in kΩ.

**FIGURE 15-3: CLKOUT AND I/O TIMING - PIC16C54A**



**TABLE 15-2: CLKOUT AND I/O TIMING REQUIREMENTS - PIC16C54A**

<b>Standard Operating Conditions (unless otherwise specified)</b> Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-20^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial - PIC16LV54A-02I $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended						
<b>AC Characteristics</b>						
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units
10	TosH2ckL	OSC1↑ to CLKOUT↓ <sup>(1)</sup>	—	15	30**	ns
11	TosH2ckH	OSC1↑ to CLKOUT↑ <sup>(1)</sup>	—	15	30**	ns
12	TckR	CLKOUT rise time <sup>(1)</sup>	—	5.0	15**	ns
13	TckF	CLKOUT fall time <sup>(1)</sup>	—	5.0	15**	ns
14	TckL2ioV	CLKOUT↓ to Port out valid <sup>(1)</sup>	—	—	40**	ns
15	TioV2ckH	Port in valid before CLKOUT↑ <sup>(1)</sup>	$0.25 \text{ TCY} + 30^*$	—	—	ns
16	TckH2ioI	Port in hold after CLKOUT↑ <sup>(1)</sup>	0*	—	—	ns
17	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid <sup>(2)</sup>	—	—	100*	ns
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	TBD	—	—	ns
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	TBD	—	—	ns
20	TioR	Port output rise time <sup>(2)</sup>	—	10	25**	ns
21	TioF	Port output fall time <sup>(2)</sup>	—	10	25**	ns

\* These parameters are characterized but not tested.

\*\* These parameters are design targets and are not tested. No characterization data available at this time.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

**2:** Please refer to Figure 15-1 for load conditions.

# PIC16C5X

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NOTES:

FIGURE 16-16: WDT TIMER TIME-OUT PERIOD vs. VDD<sup>(1)</sup>

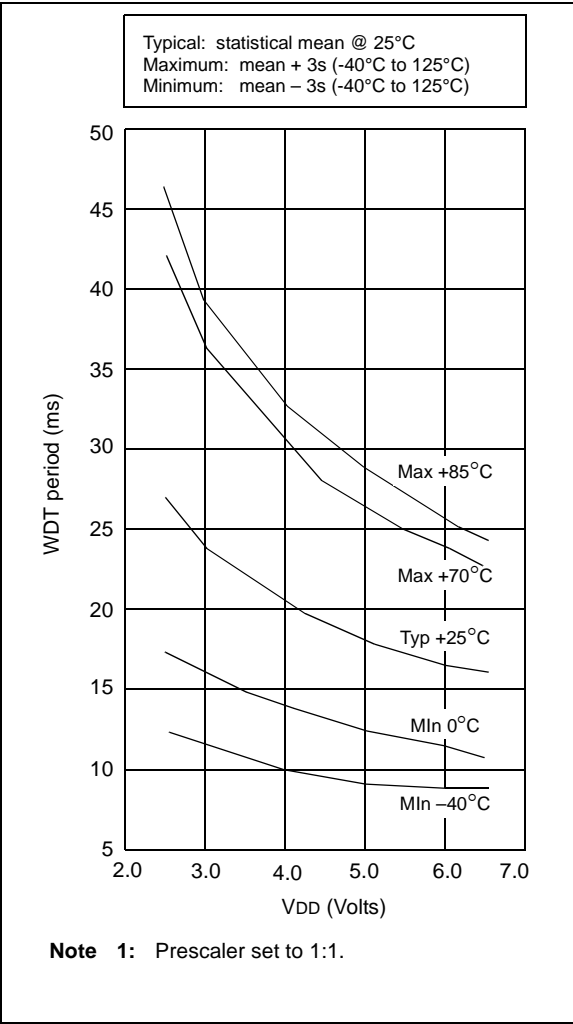
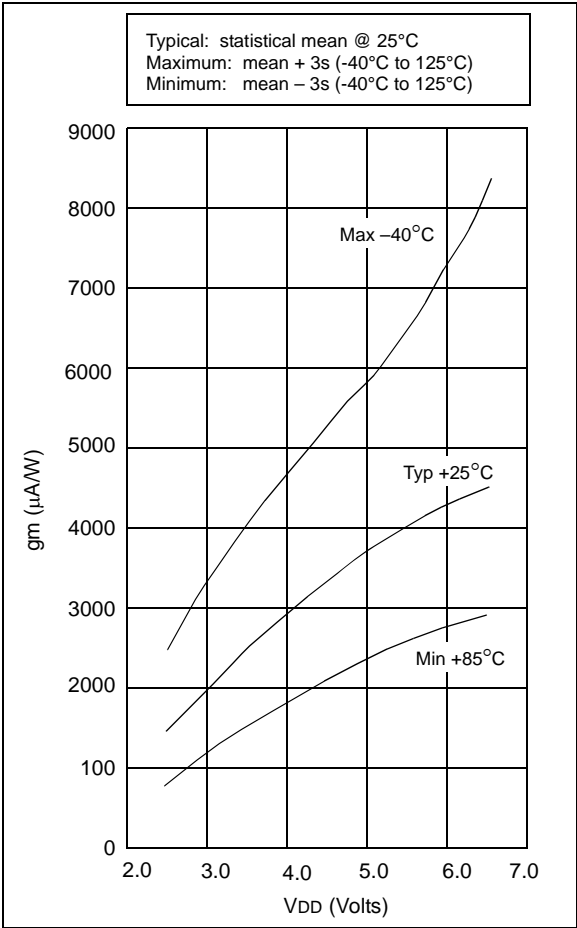


FIGURE 16-17: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. VDD



## 17.1 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

<b>PIC16LC5X</b> <b>PIC16LCR5X</b> (Commercial, Industrial)		<b>Standard Operating Conditions (unless otherwise specified)</b> Operating Temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial					
<b>PIC16C5X</b> <b>PIC16CR5X</b> (Commercial, Industrial)		<b>Standard Operating Conditions (unless otherwise specified)</b> Operating Temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial					
Param No.	Symbol	Characteristic/Device	Min	Typ†	Max	Units	Conditions
D010	IDD	<b>Supply Current<sup>(2,3)</sup></b>					
		PIC16LC5X	—	0.5	2.4	mA	FOSC = 4.0 MHz, VDD = 5.5V, XT and RC modes
			—	11	27	μA	FOSC = 32 kHz, VDD = 2.5V, LP mode, Commercial
D010A		PIC16C5X	—	14	35	μA	FOSC = 32 kHz, VDD = 2.5V, LP mode, Industrial
			—	1.8	2.4	mA	FOSC = 4 MHz, VDD = 5.5V, XT and RC modes
			—	2.6	3.6*	mA	FOSC = 10 MHz, VDD = 3.0V, HS mode
			—	4.5	16	mA	FOSC = 20 MHz, VDD = 5.5V, HS mode
			—	14	32	μA	FOSC = 32 kHz, VDD = 3.0V, LP mode, Commercial
			—	17	40	μA	FOSC = 32 kHz, VDD = 3.0V, LP mode, Industrial

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

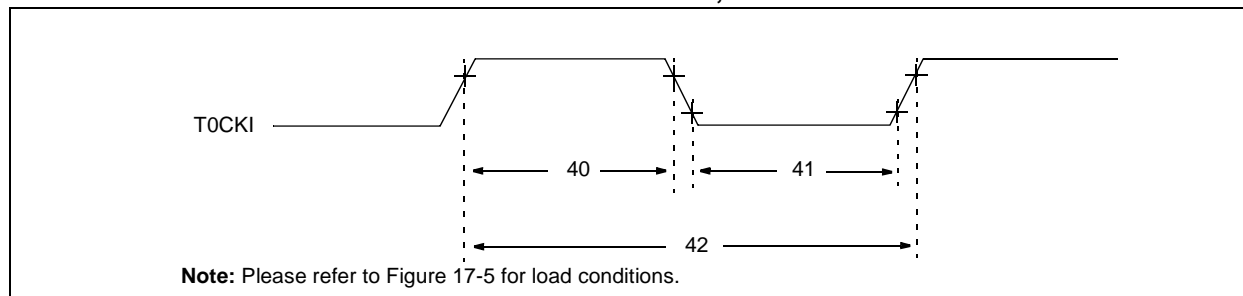
b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.



# PIC16C5X

**FIGURE 17-9: TIMER0 CLOCK TIMINGS - PIC16C5X, PIC16CR5X**



**TABLE 17-4: TIMER0 CLOCK REQUIREMENTS - PIC16C5X, PIC16CR5X**

AC Characteristics		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature					
		0°C ≤ TA ≤ +70°C for commercial					
		–40°C ≤ TA ≤ +85°C for industrial					
		–40°C ≤ TA ≤ +125°C for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width					
		- No Prescaler	0.5 Tcy + 20*	—	—	ns	
		- With Prescaler	10*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width					
		- No Prescaler	0.5 Tcy + 20*	—	—	ns	
		- With Prescaler	10*	—	—	ns	
42	Tt0P	T0CKI Period	20 or $\frac{Tcy + 40}{N}$ *	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

## 19.0 ELECTRICAL CHARACTERISTICS - PIC16LC54C 40MHz

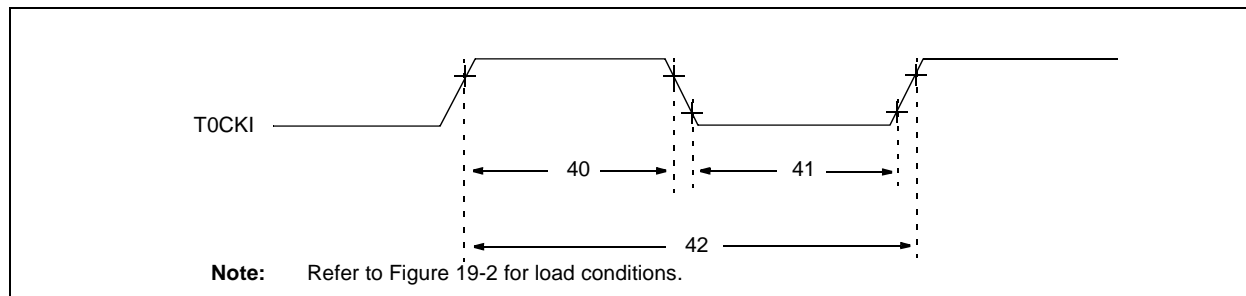
### Absolute Maximum Ratings<sup>(†)</sup>

Ambient temperature under bias .....	–55°C to +125°C
Storage temperature .....	–65°C to +150°C
Voltage on VDD with respect to VSS .....	0 to +7.5V
Voltage on MCLR with respect to VSS.....	0 to +14V
Voltage on all other pins with respect to VSS .....	–0.6V to (VDD + 0.6V)
Total power dissipation <sup>(1)</sup> .....	800 mW
Max. current out of Vss pin .....	150 mA
Max. current into VDD pin .....	100 mA
Max. current into an input pin (T0CKI only) .....	±500 µA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > VDD).....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > VDD) .....	±20 mA
Max. output current sunk by any I/O pin .....	25 mA
Max. output current sourced by any I/O pin .....	20 mA
Max. output current sourced by a single I/O (Port A, B or C) .....	50 mA
Max. output current sunk by a single I/O (Port A, B or C).....	50 mA

**Note 1:** Power dissipation is calculated as follows:  $P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD}-V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

† NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**FIGURE 19-6: TIMER0 CLOCK TIMINGS - PIC16C5X-40**



**TABLE 19-4: TIMER0 CLOCK REQUIREMENTS PIC16C5X-40**

AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	$10^*$	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	$10^*$	—	—	ns	
42	Tt0P	T0CKI Period	$20 \text{ or } \frac{T_{CY} + 40^*}{N}$	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

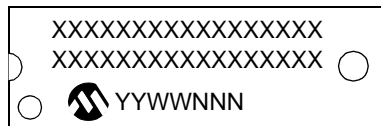
\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

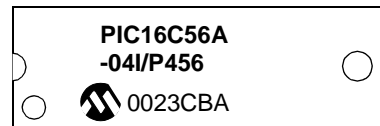
## 21.0 PACKAGING INFORMATION

### 21.1 Package Marketing Information

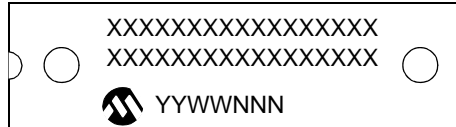
#### 18-Lead PDIP



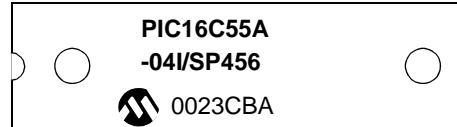
#### Example



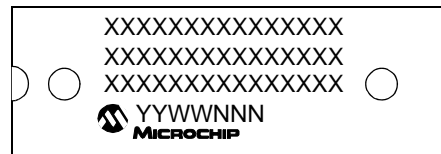
#### 28-Lead Skinny PDIP (.300")



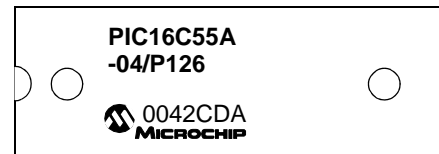
#### Example



#### 28-Lead PDIP (.600")



#### Example



#### 18-Lead SOIC



#### Example



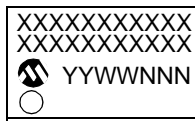
#### 28-Lead SOIC



#### Example



#### 20-Lead SSOP



#### Example



#### 28-Lead SSOP



#### Example



W

W Register  
    Value on reset ..... 20  
Wake-up from SLEEP ..... 19, 47  
Watchdog Timer (WDT) ..... 43, 46  
    Period ..... 46  
    Programming Considerations ..... 46  
    Register values on reset ..... 20  
WWW, On-Line Support ..... 3

X

XORLW ..... 60  
XORWF ..... 60

Z

Zero (Z) bit ..... 9, 29